# MULTI LAYER CERAMIC CAPACITORS

# - GML SERIES -

# DESCRIPTION

- MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used.
- CCE GML series MLCC is used in product having thickness concerned generally have high capacitance and thinner product thickness. The high dielectric constant material X7R and X5R are used for this series product.

### **FEATURES**

- Standard size with thin thickness.
- Small size with high capacitance.
- Capacitor with lead-free termination (pure Tin).



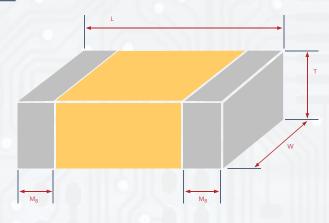
### **APPLICATIONS**

- For LCD panels.
- For PCMCA cards.
- For IC packaging and modules.
- Any thickness concerned products.



## ORDERING INFORMATION





SIZE INCH (MM)	L (MM)	W (MM)	T (MM) SYMBO	MB (MM)	
0402 (1005)	1.00 ± 0.2	0.5 ± 0.2	0.30 ± 0.03	L	0.25 ± 0.10
0603 (1608)	1.6 +15 / -0.10	0.8+ 0.15 / - 0.10	0.50 ± 0.10	Н	0.40 ± 0.15
0805 (2012)	2.00 ± 0.20	1.25±0.20	0.85 ± 0.10	Т	0.50 ± 0.20
1206			0.85 ± 0.10	Т	
(3216)	3.20 ± 0.20	1.60 ± 0.20	1.15 ± 0.15	J	0.60 ± 0.20
			0.85 ± 0.10	Т	
1210 (3225)	3.20 ± 0.30	2.50±0.20	1.25 ± 0.10	U	0.75 ± 0.25
(OLLO)			2.00 ± 0.20	К	

GML	21	X5R	475	K	6R3	N	Т
SERIES	SIZE	DIELECTRIC	CAPACITANCE	TOLERANCE	VOLTAGE	TERMINATION	PACKAGING
GML - Low Profile	04 - 0402 (1005) 10 - 0603 (1608) 21 - 0805 (2012) 31 - 1206 (3216) 32 - 1210 (3225)	X7R X5R	Two significant digits followed by no. of zeros. And R is in place of decimal point.	K: ±10% M: ±20%	Two significant digits followed by no. of zeros. And R is in place of decimal point.	N: Cu / Ni / Sn	T: 7" reeled G: 13" reeled
GENERAL		0	eg.: 475 =47x105 =4,700,000 pF =4.7µF		6R3: 6.3 VDC 10: 10 VDC 16: 16 VDC 25: 25 VDC 50: 50 VDC 100: 100 VDC 200: 200 VDC		

## GENERAL ELECTRICAL DATA

DIELECTRIC	X7R	X5R				
SIZE	0402, 0603, 0805, 1206, 1210					
CAPACITANCE RANGE*	0.1μF to 10μF	0.22μF to 47μF				
CAPACITANCE TOLERANCE**	K (±10%), M (±20%)					
RATED VOLTAGE	10V, 16V, 25V, 50V, 100V, 200V	6.3V, 10V, 16V, 25V				
OPERATING TEMPERATURE	-55 to +125°C	-55 to +85°C				
CAPACITANCE CHARACTERISTIC	±159	%				
TERMINATION	Ni / Sn (lead-free	termination)				

<sup>\*</sup> Measured at 1.0±0.2Vrms, 1.0kHz±10%, 30~70% related humidity, 25°C ambient temperature for X7R, X5R.

\*\* Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement









# CAPACITANCE RANGE

### - X7R DIELECTRIC

	DIELECT	ΓRIC					П	X	7R					
	SIZE			08	05			12	06			12	10	
F	RATED VO	LTAGE	10	16	25	50	10	16	25	50	10	16	100	200
	0.10uF	104												
	0.22uF	224												
	0.33uF	334												
	0.47uF	474				TH								
ЭE	0.68uF	684												
CAPACITANCE RANGE	0.82uF	824												
Ş	1.0uF	105							Т					
ΗA	1.5uF	155		T.							17%			
PAC	2.2uF	225		Т	Т					Т			К	
S	3.3uF	335												
	4.7uF	475	T						T					
	6.8uF	685												
	10uF	106					Т							
	22uF	226												

### - X5R DIELECTRIC

	DIELECT	TRIC				1				10	X	5R	e n	34.						
	SIZE			0402			0603			08	05				1206				1210	
ı	RATED VO	LTAGE	6.3	10	25	6.3	10	16	6.3	10	16	25	6.3	10	16	25	50	10	16	25
	0.22uF	224					Н	Н												
	0.47uF	474	F	1																
1,	1.0uF	105	L				Н	н												
NGE	1.5uF	155										1								
E R/	2.2uF	225	L						Т											
ANC	3.3uF	335			0															
CAPACITANCE RANGE	4.7uF	475	L				н		Т	Т	Т	Т								
CAP/	6.8uF	685																		
	10uF	106				G			Т	Т	Т		J	J/T		Т		Т		Т
	22uF	226							Т						Т				Т	
	47uF	476					1		Т							1	4			

# PACKAGING STYLE AND REEL SIZE

CIZE	THICKNES	S MASS	7" REEL					
SIZE	(MM) / SY	/MBOL	PAPER TAPE	PLASTIC TAPE				
0402 (1005)	0.22	F	10k					
0402 (1005)	0.33	L	15k	-				
0603 (1608)	0.50	G	4k					
0603 (1608)	0.60	Н	4k					
0805 (2012)	0.95	Т	4k	-				
1207 (2217)	0.95	Т	4k					
1206 (3216)	1.30	J		3k				
41	0.95	Т	-	3k				
1210 (3225)	1.35	U	_	3k				
	2.00	K		1k				











## RELIABILITY TEST CONDITIONS AND REQUIREMENTS

NO.	ITEMS	TEST	CONDITION		REQUIF	REMENTS
1.	Visual and Mechanical		m ///	- No remarkal - Dimensions		ividual specification sheet.
2.	Capacitance	- Test temp.: Room Temper		- Shall not exc	ceed the limits giv	ven in the detailed spec.
3.		Cap≤10μF, 1.0±0.2Vrms, 1k Cap>10μF, 0.5±0.2Vrms, 12		X7R / X5R:	RATED VOL.	D.F.
	Q/ D.F.	** Test condition: 0.5±0.2V	rms, 1KHz±10%		100V, 200V	≤5%
	(Dissipation Factor)	GML10 X5R ≥475(10V), GN	ML04 X5R series		50V, 25V, 16V, 10V	≤10%
	ractory	*Before initial measurement 150°C for 1hr then set for 2	t (Class II only): To apply de-aging at		6.3V	≤5%
4.	Dielectric Strength	- To apply voltage: 250% ra - Duration: 1 to 5 sec. - Charge and discharge cur	ted voltage.	- No evidence	e of damage or fla	ash over during test.
5.	Insulation Resistance	- Test temp.: Room Temper - To apply rated voltage for		≥10GΩ or Rx	C ≥ 100Ω - F whic	chever is smaller.
6.		With no electrical load.			ТУЛ	
		T.C.	OPERATING TEMPERATURE		T.C.	CAPACITANCE CHANGE
		X7R	-55~125°C at 25°C		X7R	Within ±15%
		X5R	-55~85°C at 25°C		X5R	Within ±15%
		- Before initial measuremen To apply de-aging at 150°C room temp. - Measurement voltage for	for 1hr then set for 24± 2 hrs at			
		0402	0603			
		Cap<1μF: 1V	Cap<1µF: 1V			
	Temperature Coefficient	Cap=1µF: 0.5V** 0402 X7R 224-16V: 0.5 0402 X7R 474-10V: 0.5 0402 X5R 475M6R3: 0.	V 0603 X5R 106-10V: 0.5V			
		1μF <cap<10μf: 0.2v<br="">**0402 X7R 105M6R3V: 0</cap<10μf:>		1/1		
$\mathcal{M}$		Cap≥10μF: 0.1V				
		0805	1206 / 1210			
		Cap<10μF: 1V	Cap<10µF: 1V			
		Cap=10µF: 0.5V 0805 X7R 475/6.3V~25V:	0.5V 10μF <cap≤100μf: 0.5v<="" td=""><td>/1</td><td></td><td></td></cap≤100μf:>	/1		
		Cap>10μF: 0.2V	Cap>100µF: 0.2V 1206 X5R 107-6.3V: 0.2V	9		
7.	Adhesive Strength of Termination	- Pressurizing force: 5N (≤ 0 - Test time: 10±1 sec.	0603) and 10N (>0603)	- No remarkal	ole damage or re	moval of the terminations.
8.	Vibration Resistance	- Total amplitude: 1.5mm - Test time: 6 hrs. (Two hrs e perpendicular directions.) - Before initial measuremen To apply de-aging at 150°C room temp. - Cap./DF(Q) Measurement	est time: 6 hrs. (Two hrs each in three mutually properties).  In the foreign of the following services of the following s			neet initial spec.
9.	Solderability	- Solder temperature: 235± - Dipping time: 2±0.5 sec.	5°C	- 95% min. co	verage of all met	alized area.
10.	Bending Test	1 mm per second until the the pressure shall be mainta - Before initial measuremen To apply de-aging at 150°C room temp.	e pressurizing rod at a rate of about deflection becomes 1 mm and then ained for 5±1 sec.	(This ca capacit	: X7R/X5R: within pacitance change ance underspecif	±12.5% e means the change of ied flexure of substrate easured before the test.)







## RELIABILITY TEST CONDITIONS AND REQUIREMENTS

NO.	ITEMS	TEST CONDITION	REQUIREMENTS			
11.	Resistance to Soldering Heat	- Solder temperature: 260±5°C - Dipping time: 10±1 sec - Preheating: 120 to 150°C for 1 minute before imme rse the capacitor in a eutectic solder Before initial measurement (Class II only): To apply de-aging at 150°C for 1hr then set for 24±2 hrs at room temp Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150°C for 1hr then set for 24±2 hrs at room temp.	- No remarkable damage Cap change: X7R/X5R: within ±7.5% - Q/D.F., I.R. and dielectric strength: To meet initial requirements 25% max. leaching on each edge.			
12.	Temperature Cycle	- Conduct the five cycles according to the temperatures and time.    TEMP. (°C)   TIME (MIN)	- No remarkable damage Cap change: X7R/X5R: within ±7.5% - Q/D.F., I.R. and dielectric strength: To meet initial requirements.			
13.	Humidity (Damp Heat) Steady State	- Test temp.: 40±2°C - Humidity: 90~95% RH - Test time: 500+24/-0hrs Before initial measurement (Class II only): To apply de-aging at 150°C for 1hr then set for 24±2 hrs at room temp Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150°C for 1hr then set for 24±2 hrs at room temp.	- No remarkable damage Cap change: X7R/X5R: within ±25% - Q/D.F. value: X7R/X5R:  RATED VOL.  100V, 200V  ≤7.5%  25V, 16V  110V  ≤20%  50V, 6.3V  - I.R.: 1G Ω or RxC≥10 Ω -F whichever is smaller.			
14.	Humidity (Damp Heat) Load	- Test temp.: 40±2°C - Humidity: 90~95%RH - Test time: 500+24/-0 hrs To apply voltage: Rated voltage Before initial measurement (Class II only): To apply de-aging at 150°C for 1hr then set for 24±2 hrs at room temp Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150°C for 1hr then set for 24±2 hrs at room temp.	No remarkable damage.  *Cap change: X7R/X5R: within ±25%  *Q/D.F. value: X7R/X5R:  RATED VOL.  100V, 200V  25V, 16V  25V, 16V  10V  ≤20%  50V, 6.3V  - I.R.: 500MΩ or RxC≥5 Ω-F whichever is smaller.			
15.	High Temperature Load (Endurance)	- Test temp.: X7R: 125±3°C   X5R: 85±3°C - Test time: 1000+24/-0 hrs To apply voltage: 150% of rated voltage. **100% of rated voltage for below range.    SIZE   DIELECTRIC   RATED   CAPACITANE   RANGE	- No remarkable damage Cap change: X7R/X5R: within ±25% - Q/D.F. value: X7R/X5R:  RATED VOL.  100V, 200V  ≤7.5%  25V, 16V  10V  ≤20%  50V, 6.3V  ≤30%			
15.	Temperature Load	SIZE   DIELECTRIC   VOLTAGE   RANGE	_			

<sup>\* &</sup>quot;Room condition" Temperature: 15 to 35°C, Relative humidity: 25 to 75%, Atmospheric pressure: 86 to 106kPa.





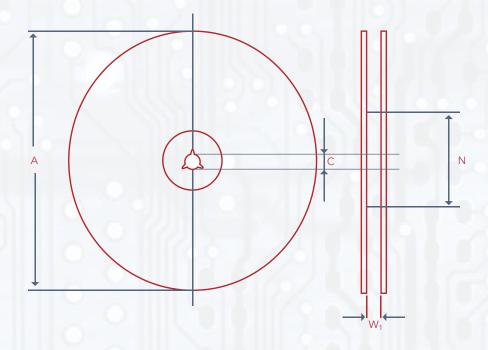


## RELIABILITY TEST CONDITIONS AND REQUIREMENTS

NO.	ITEMS		TEST CO	ONDITION	9/		REQUIR	REMENTS
		- Test time - To apply	p.: X7R: 125±3°C   X e: 1000+24/-0 hrs. voltage: 150% of rat f rated voltage for be	ted voltage.			kable damage. ge: X7R/X5R: within ue:	±25%
	High	SIZE	DIELECTRIC	RATED	CAPACITANE	1/ 6	RATED VOL.	D.F.
4.5	Temperature			VOLTAGE	RANGE	-	100V, 200V	≤7.5%
15.	Load	GML04	X5R	6.3V	C ≥ 1.0 µF		25V, 16V	≤15%
	(Endurance)	GML21	X5R I X7R	≤10V	C ≥ 10 µF		10V	≤20%
		at 150°C f	nitial measurement (C for 1hr then set for 24 DF(Q) / I.R. Measure	4±2 hrs at room	temp.		50V, 6.3V	≤30%
			en set for 24±2 hrs at			- I.R.: 1GΩ (	or RxC≥10Ω-F which	hever is smaller.



# TAPE AND REEL DIMENSION



SIZE		0402, 0603, 0805, 1206, 1210	
REEL SIZE	7"	10"	13"
С	13.0±0.5	13.0±0.5	13.0±0.5
W <sub>1</sub>	10.0±1.5	10.0±1.5	10.0±1.5
А	178.0±2.0	250.0±2.0	330.0±2.0
N	60.0+1.0/-0	50 min	50 min

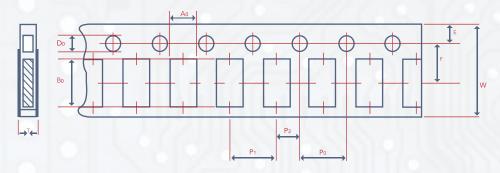




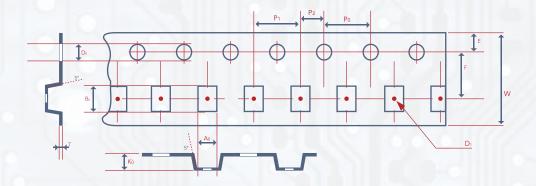


# TAPE AND REEL DIMENSIONS

-The dimension of paper tape



-The dimension of plastic tape



SIZE	0402	0603	0805	12	06	12	10
THICKNESS	L	Н	Т	Т	J	Т	К
A <sub>0</sub>	0.70 ± 0.20	1.05 ± 0.30	1.50 ± 0.20	1.90 ± 0.50	<2.00	<3.05	<3.05
B <sub>0</sub>	1.20 ± 0.20	1.80 ± 0.30	2.30 ± 0.20	$3.50 \pm 0.50$	<3.70	<3.80	<3.80
Т	≤0.80	≤1.20	≤1.20	≤1.20	0.23 ± 0.1	0.23 ± 0.1	0.23 ± 0.1
K <sub>0</sub>		- 16	7.1-17		<2.00	<1.50	<2.50
W	8.00 ± 0.30	8.00 ± 0.30	8.00 ± 0.30	8.00 ± 0.30	8.00 ± 0.30	8.00 ± 0.30	8.00 ± 0.30
P <sub>0</sub>	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10
10XP <sub>0</sub>	40.00 ± 0.10	40.00 ± 0.20	40.00 ± 0.20	40.00 ± 0.20	40.00 ± 0.20	40.00 ± 0.20	40.00 ± 0.20
P <sub>1</sub>	2.00 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	4.00 ± 0.10
P <sub>2</sub>	2.00 ± 0.05	2.00 ± 0.05	2.00 ± 0.05	2.00 ± 0.05	2.00 ± 0.05	2.00 ± 0.05	2.00 ± 0.05
D <sub>0</sub>	1.50 +0.1 / -0	1.50 +0.1 / -0	1.50 +0.1 / -0	1.50 +0.1 / -0	1.50 +0.1 / -0	1.50 +0.1 / -0	1.50 +0.1 / -0
D <sub>1</sub>		1.7	-	-	1.00 ± 0.10	1.00 ± 0.10	1.00 ± 0.10
E	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10
F	3.50 ± 0.05	3.50 ± 0.05	3.50 ± 0.05	3.50 ± 0.05	3.50 ± 0.05	3.50 ± 0.05	$3.50 \pm 0.05$

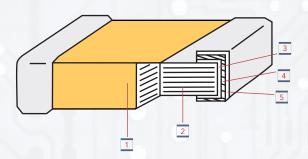








# CONSTRUCTIONS



NO.	N/	X7R, X5R			
1	Cerami	Ceramic Material			
2	Inner E	Electrode	Ni		
3		Inner Layer	Cu		
4	Termination	Middle Layer	Ni		
5		Outer Layer	Sn (Matt)		

### STORAGE AND HANDLING CONDITIONS

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

### Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

### RECOMMENDED SOLDERING CONDITIONS

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N2 within oven are recommended.

